

Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

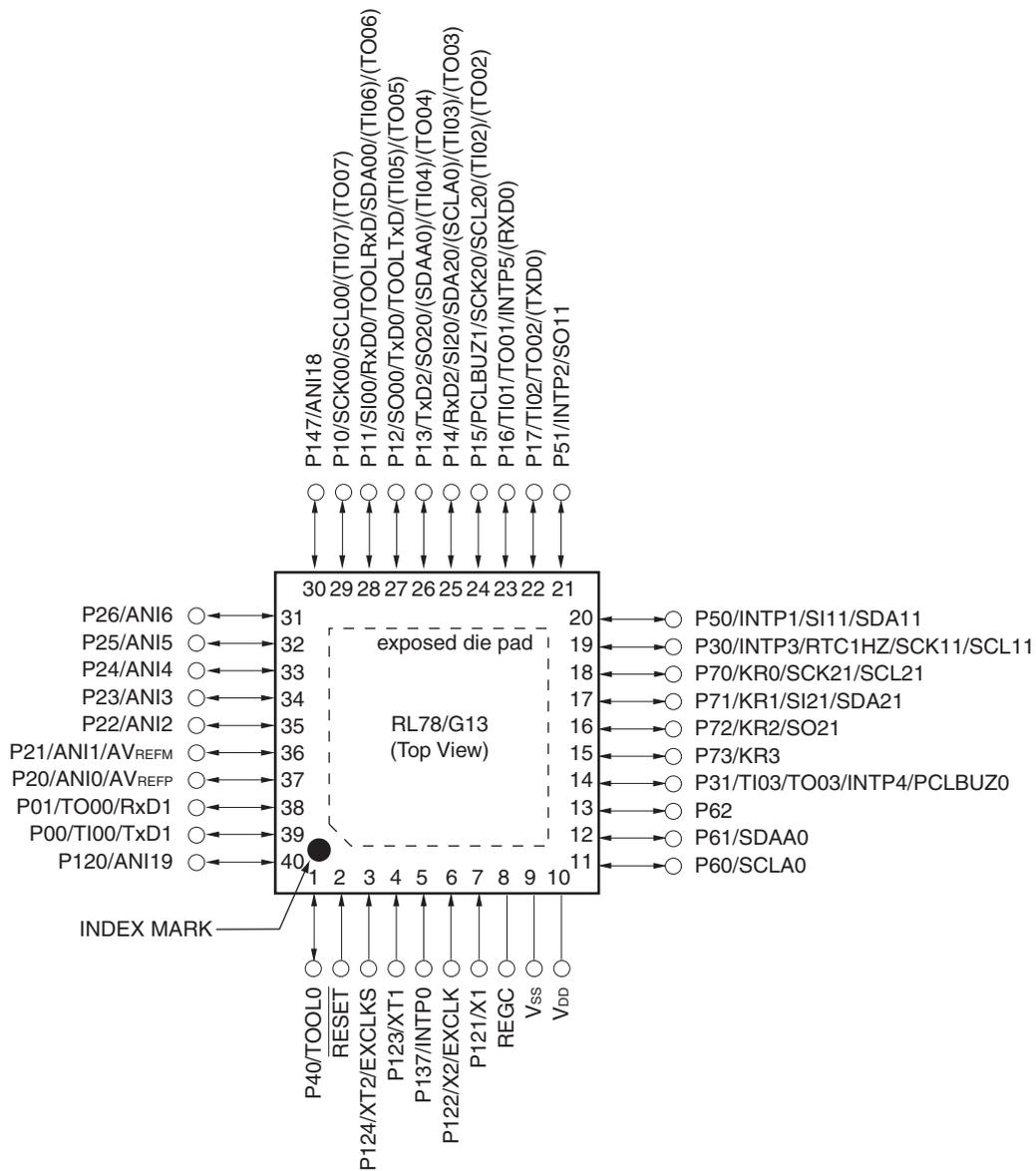
Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Obsolete |
| Core Processor | RL78 |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CSI, I ² C, LINbus, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 34 |
| Program Memory Size | 256KB (256K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | 8K x 8 |
| RAM Size | 20K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V |
| Data Converters | A/D 10x8/10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 48-LQFP |
| Supplier Device Package | 48-LFQFP (7x7) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100gjdfb-x0 |

1.3.7 40-pin products

- 40-pin plastic HWQFN (6 × 6 mm, 0.5 mm pitch)



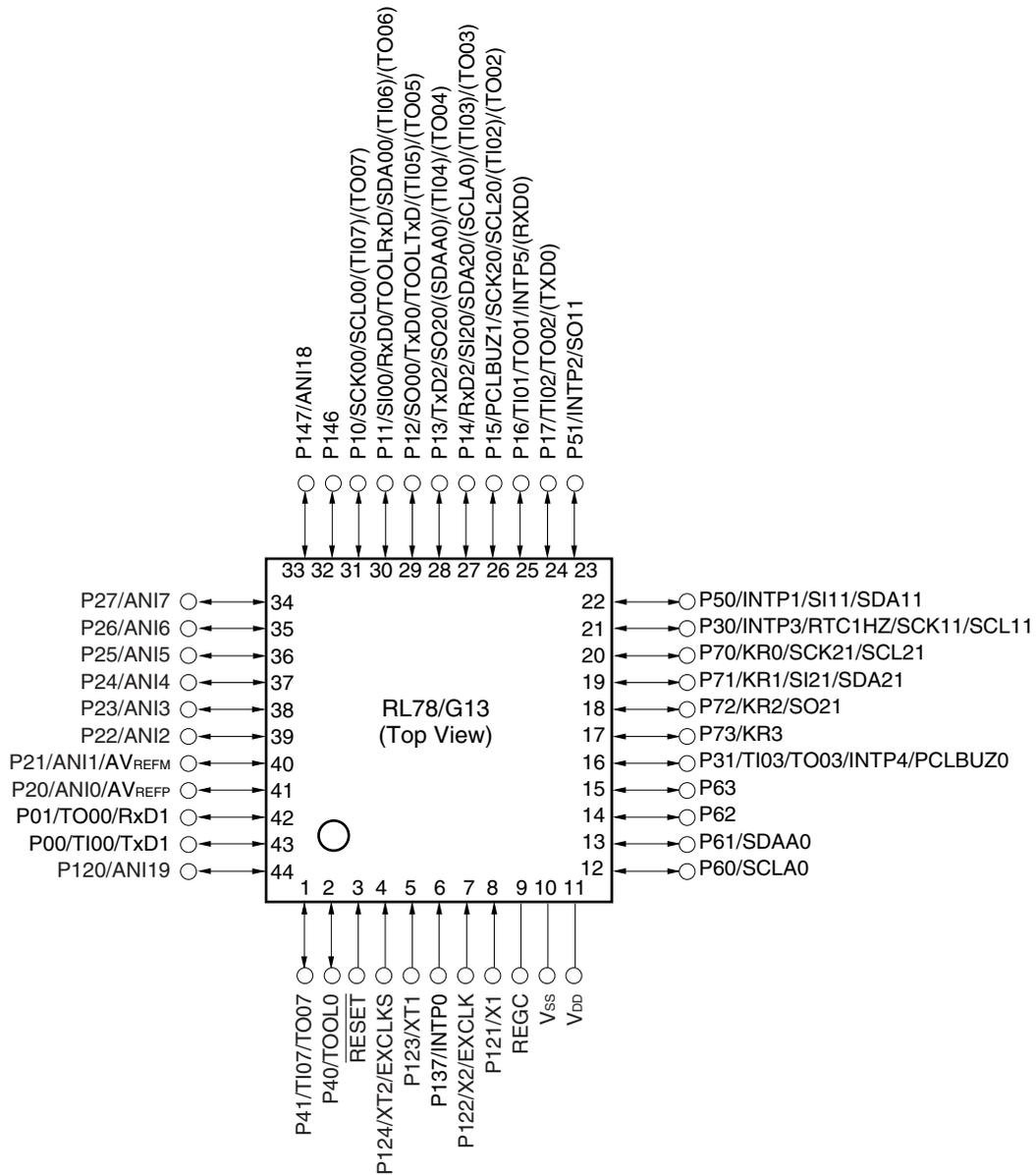
Caution Connect the REGC pin to V_{SS} via a capacitor (0.47 to 1 μF).

Remarks 1. For pin identification, see 1.4 Pin Identification.

- Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.
- It is recommended to connect an exposed die pad to V_{SS}.

1.3.8 44-pin products

- 44-pin plastic LQFP (10 × 10 mm, 0.8 mm pitch)



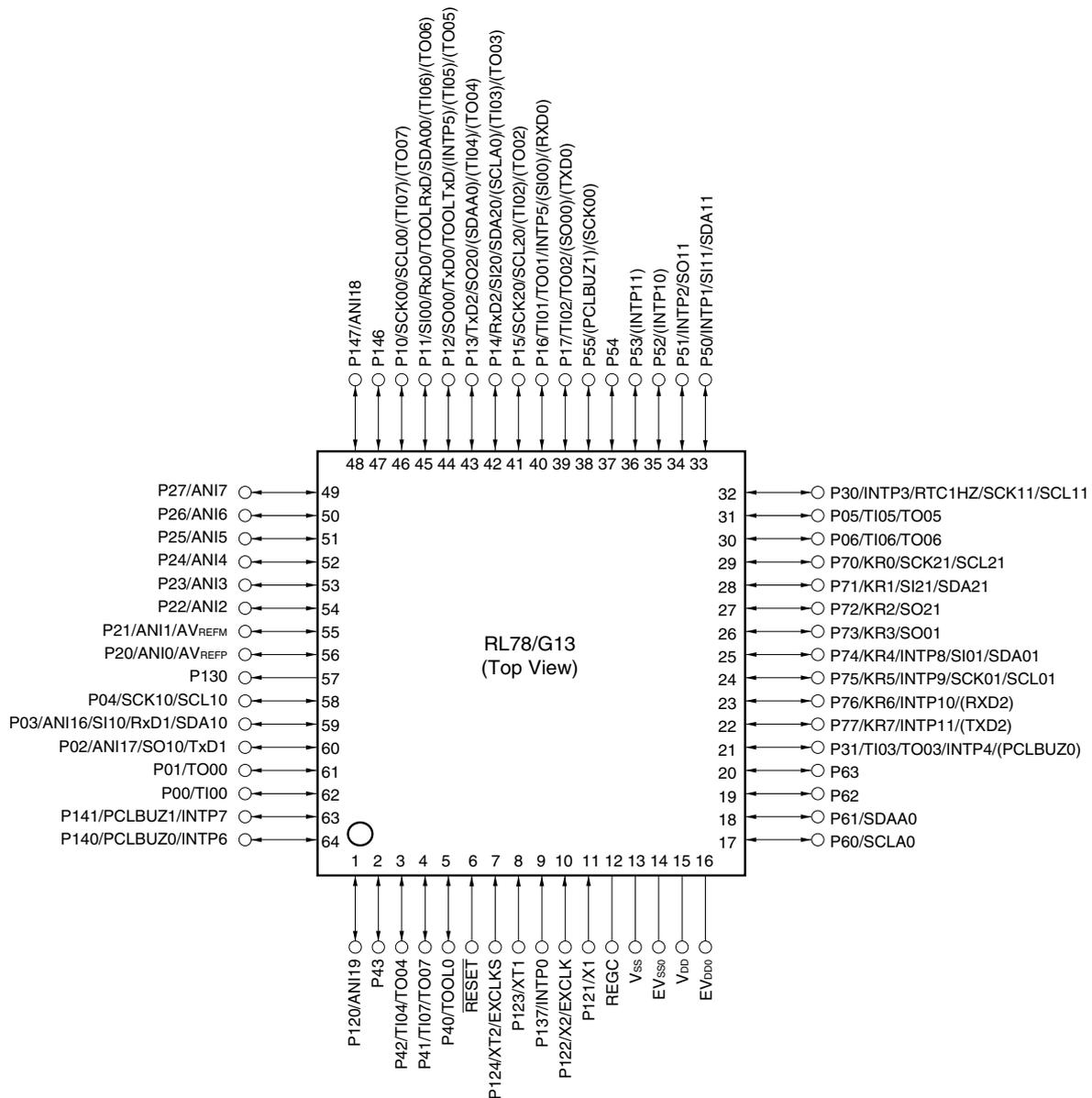
Caution Connect the REGC pin to V_{SS} via a capacitor (0.47 to 1 μF).

Remarks 1. For pin identification, see 1.4 Pin Identification.

2. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

1.3.11 64-pin products

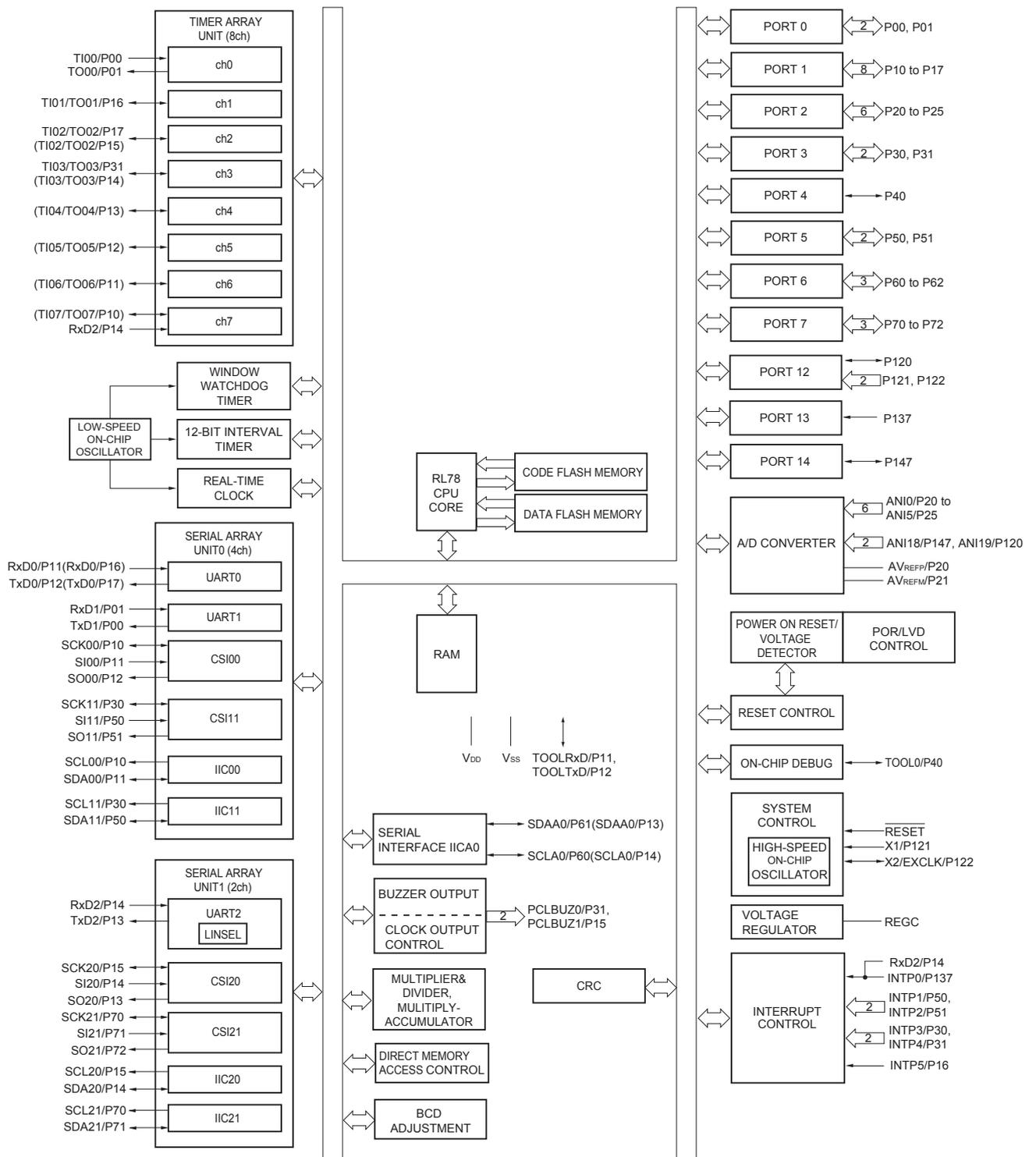
- 64-pin plastic LQFP (12 × 12 mm, 0.65 mm pitch)
- 64-pin plastic LFQFP (10 × 10 mm, 0.5 mm pitch)



- Cautions**
1. Make EV_{SS0} pin the same potential as V_{SS} pin.
 2. Make V_{DD} the potential that is higher than EV_{DD0} pin.
 3. Connect the REGC pin to V_{SS} via a capacitor (0.47 to 1 μF).

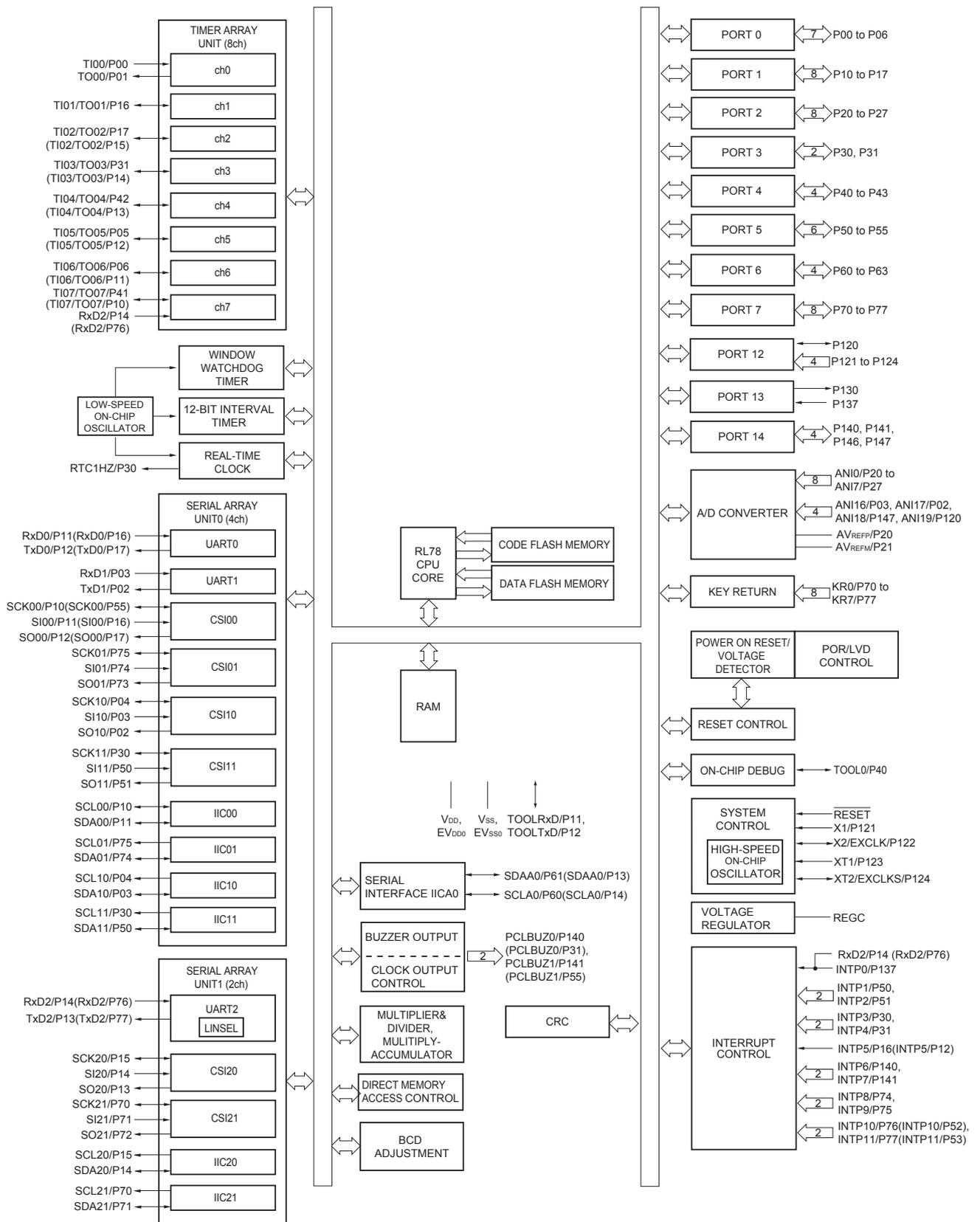
- Remarks**
1. For pin identification, see 1.4 Pin Identification.
 2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V_{DD} and EV_{DD0} pins and connect the V_{SS} and EV_{SS0} pins to separate ground lines.
 3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

1.5.6 36-pin products



Remark Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

1.5.11 64-pin products



Remark Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

1.6 Outline of Functions

[20-pin, 24-pin, 25-pin, 30-pin, 32-pin, 36-pin products]

Caution This outline describes the functions at the time when Peripheral I/O redirection register (PIOR) is set to 00H.

(1/2)

| Item | 20-pin | | 24-pin | | 25-pin | | 30-pin | | 32-pin | | 36-pin | | |
|------------------------------------|---|---|--|--|--|--|---|----------|--------------------------|----------|--------------------------|----------|--|
| | R5F1006x | R5F1016x | R5F1007x | R5F1017x | R5F1008x | R5F1018x | R5F100Ax | R5F101Ax | R5F100Bx | R5F101Bx | R5F100Cx | R5F101Cx | |
| Code flash memory (KB) | 16 to 64 | | 16 to 64 | | 16 to 64 | | 16 to 128 | | 16 to 128 | | 16 to 128 | | |
| Data flash memory (KB) | 4 | – | 4 | – | 4 | – | 4 to 8 | – | 4 to 8 | – | 4 to 8 | – | |
| RAM (KB) | 2 to 4 ^{Note1} | | 2 to 4 ^{Note1} | | 2 to 4 ^{Note1} | | 2 to 12 ^{Note1} | | 2 to 12 ^{Note1} | | 2 to 12 ^{Note1} | | |
| Address space | 1 MB | | | | | | | | | | | | |
| Main system clock | High-speed system clock | X1 (crystal/ceramic) oscillation, external main system clock input (EXCLK) HS (High-speed main) mode: 1 to 20 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | | | |
| | High-speed on-chip oscillator | HS (High-speed main) mode: 1 to 32 MHz (V _{DD} = 2.7 to 5.5 V), HS (High-speed main) mode: 1 to 16 MHz (V _{DD} = 2.4 to 5.5 V), LS (Low-speed main) mode: 1 to 8 MHz (V _{DD} = 1.8 to 5.5 V), LV (Low-voltage main) mode: 1 to 4 MHz (V _{DD} = 1.6 to 5.5 V) | | | | | | | | | | | |
| Subsystem clock | – | | | | | | | | | | | | |
| Low-speed on-chip oscillator | 15 kHz (TYP.) | | | | | | | | | | | | |
| General-purpose registers | (8-bit register × 8) × 4 banks | | | | | | | | | | | | |
| Minimum instruction execution time | 0.03125 μs (High-speed on-chip oscillator: f _{IH} = 32 MHz operation) | | | | | | | | | | | | |
| | 0.05 μs (High-speed system clock: f _{MX} = 20 MHz operation) | | | | | | | | | | | | |
| Instruction set | <ul style="list-style-type: none"> • Data transfer (8/16 bits) • Adder and subtractor/logical operation (8/16 bits) • Multiplication (8 bits × 8 bits) • Rotate, barrel shift, and bit manipulation (Set, reset, test, and Boolean operation), etc. | | | | | | | | | | | | |
| I/O port | Total | 16 | 20 | 21 | 26 | 28 | 32 | | | | | | |
| | CMOS I/O | 13 (N-ch O.D. I/O [V _{DD} withstand voltage]: 5) | 15 (N-ch O.D. I/O [V _{DD} withstand voltage]: 6) | 15 (N-ch O.D. I/O [V _{DD} withstand voltage]: 6) | 21 (N-ch O.D. I/O [V _{DD} withstand voltage]: 9) | 22 (N-ch O.D. I/O [V _{DD} withstand voltage]: 9) | 26 (N-ch O.D. I/O [V _{DD} withstand voltage]: 10) | | | | | | |
| | CMOS input | 3 | 3 | 3 | 3 | 3 | 3 | | | | | | |
| | CMOS output | – | – | 1 | – | – | – | | | | | | |
| | N-ch O.D. I/O (withstand voltage: 6 V) | – | 2 | 2 | 2 | 3 | 3 | | | | | | |
| Timer | 16-bit timer | 8 channels | | | | | | | | | | | |
| | Watchdog timer | 1 channel | | | | | | | | | | | |
| | Real-time clock (RTC) | 1 channel ^{Note 2} | | | | | | | | | | | |
| | 12-bit interval timer (IT) | 1 channel | | | | | | | | | | | |
| | Timer output | 3 channels (PWM outputs: 2 ^{Note 3}) | 4 channels (PWM outputs: 3 ^{Note 3}) | | | | 4 channels (PWM outputs: 3 ^{Note 3}), 8 channels (PWM outputs: 7 ^{Note 3}) ^{Note 4} | | | | | | |
| | RTC output | – | | | | | | | | | | | |

- Notes**
- The flash library uses RAM in self-programming and rewriting of the data flash memory. The target products and start address of the RAM areas used by the flash library are shown below.
R5F100xD, R5F101xD (x = 6 to 8, A to C): Start address FF300H
R5F100xE, R5F101xE (x = 6 to 8, A to C): Start address FEF00H
For the RAM areas used by the flash library, see **Self RAM list of Flash Self-Programming Library for RL78 Family (R20UT2944)**.
 - Only the constant-period interrupt function when the low-speed on-chip oscillator clock (f_{IL}) is selected

3. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).
4. When setting to PIOR = 1

(2/2)

| Item | 20-pin | | 24-pin | | 25-pin | | 30-pin | | 32-pin | | 36-pin | | |
|---|--|----------|------------|-----------|------------|-----------|------------|-----------|------------|-----------|------------|-----------|--|
| | R5F1006x | R5F1016x | R5F1007x | R5F1017x | R5F1008x | R5F1018x | R5F100Ax | R5F101Ax | R5F100Bx | R5F101Bx | R5F100Cx | R5F101Cx | |
| Clock output/buzzer output | - | | 1 | | 1 | | 2 | | 2 | | 2 | | |
| | <ul style="list-style-type: none"> • 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: $f_{MAIN} = 20$ MHz operation) | | | | | | | | | | | | |
| 8/10-bit resolution A/D converter | 6 channels | | 6 channels | | 6 channels | | 8 channels | | 8 channels | | 8 channels | | |
| Serial interface | [20-pin, 24-pin, 25-pin products] <ul style="list-style-type: none"> • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel [30-pin, 32-pin products] <ul style="list-style-type: none"> • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I²C: 1 channel/UART (UART supporting LIN-bus): 1 channel [36-pin products] <ul style="list-style-type: none"> • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel • CSI: 1 channel/simplified I²C: 1 channel/UART: 1 channel • CSI: 2 channels/simplified I²C: 2 channels/UART (UART supporting LIN-bus): 1 channel | | | | | | | | | | | | |
| | I ² C bus | - | | 1 channel | |
| Multiplier and divider/multiply-accumulator | <ul style="list-style-type: none"> • 16 bits × 16 bits = 32 bits (Unsigned or signed) • 32 bits ÷ 32 bits = 32 bits (Unsigned) • 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed) | | | | | | | | | | | | |
| DMA controller | 2 channels | | | | | | | | | | | | |
| Vectored interrupt sources | Internal | 23 | | 24 | | 24 | | 27 | | 27 | | 27 | |
| | External | 3 | | 5 | | 5 | | 6 | | 6 | | 6 | |
| Key interrupt | - | | | | | | | | | | | | |
| Reset | <ul style="list-style-type: none"> • Reset by RESET pin • Internal reset by watchdog timer • Internal reset by power-on-reset • Internal reset by voltage detector • Internal reset by illegal instruction execution ^{Note} • Internal reset by RAM parity error • Internal reset by illegal-memory access | | | | | | | | | | | | |
| Power-on-reset circuit | <ul style="list-style-type: none"> • Power-on-reset: 1.51 V (TYP.) • Power-down-reset: 1.50 V (TYP.) | | | | | | | | | | | | |
| Voltage detector | <ul style="list-style-type: none"> • Rising edge : 1.67 V to 4.06 V (14 stages) • Falling edge : 1.63 V to 3.98 V (14 stages) | | | | | | | | | | | | |
| On-chip debug function | Provided | | | | | | | | | | | | |
| Power supply voltage | $V_{DD} = 1.6$ to 5.5 V ($T_A = -40$ to $+85^\circ\text{C}$) $V_{DD} = 2.4$ to 5.5 V ($T_A = -40$ to $+105^\circ\text{C}$) | | | | | | | | | | | | |
| Operating ambient temperature | $T_A = 40$ to $+85^\circ\text{C}$ (A: Consumer applications, D: Industrial applications) $T_A = 40$ to $+105^\circ\text{C}$ (G: Industrial applications) | | | | | | | | | | | | |

Note The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

<R>

2.3.2 Supply current characteristics

(1) Flash ROM: 16 to 64 KB of 20- to 64-pin products

(T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = 0 V) (1/2)

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit | |
|--|---|---|---|--|-------------------------|-------------------------|------|------|------|----|
| Supply current [†] <small>Note 1</small> | I _{DD1} | Operating mode | HS (high-speed main) mode ^{Note 5} | f _{IH} = 32 MHz ^{Note 3} | Basic operation | V _{DD} = 5.0 V | | 2.1 | | mA |
| | | | | | | V _{DD} = 3.0 V | | 2.1 | | mA |
| | | | | Normal operation | V _{DD} = 5.0 V | | 4.6 | 7.0 | mA | |
| | | | | | V _{DD} = 3.0 V | | 4.6 | 7.0 | mA | |
| | | | | f _{IH} = 24 MHz ^{Note 3} | Normal operation | V _{DD} = 5.0 V | | 3.7 | 5.5 | mA |
| | | | | | | V _{DD} = 3.0 V | | 3.7 | 5.5 | mA |
| | | | f _{IH} = 16 MHz ^{Note 3} | Normal operation | V _{DD} = 5.0 V | | 2.7 | 4.0 | mA | |
| | | | | | V _{DD} = 3.0 V | | 2.7 | 4.0 | mA | |
| | | | LS (low-speed main) mode ^{Note 5} | f _{IH} = 8 MHz ^{Note 3} | Normal operation | V _{DD} = 3.0 V | | 1.2 | 1.8 | mA |
| | | | | | | V _{DD} = 2.0 V | | 1.2 | 1.8 | mA |
| | | | LV (low-voltage main) mode ^{Note 5} | f _{IH} = 4 MHz ^{Note 3} | Normal operation | V _{DD} = 3.0 V | | 1.2 | 1.7 | mA |
| | | | | | | V _{DD} = 2.0 V | | 1.2 | 1.7 | mA |
| | | HS (high-speed main) mode ^{Note 5} | f _{MX} = 20 MHz ^{Note 2} , V _{DD} = 5.0 V | Normal operation | Square wave input | | 3.0 | 4.6 | mA | |
| | | | | | Resonator connection | | 3.2 | 4.8 | mA | |
| | | | | Normal operation | Square wave input | | 3.0 | 4.6 | mA | |
| | | | | | Resonator connection | | 3.2 | 4.8 | mA | |
| | | | f _{MX} = 10 MHz ^{Note 2} , V _{DD} = 5.0 V | Normal operation | Square wave input | | 1.9 | 2.7 | mA | |
| | | | | | Resonator connection | | 1.9 | 2.7 | mA | |
| | | | f _{MX} = 10 MHz ^{Note 2} , V _{DD} = 3.0 V | Normal operation | Square wave input | | 1.9 | 2.7 | mA | |
| | | | | | Resonator connection | | 1.9 | 2.7 | mA | |
| | | LS (low-speed main) mode ^{Note 5} | f _{MX} = 8 MHz ^{Note 2} , V _{DD} = 3.0 V | Normal operation | Square wave input | | 1.1 | 1.7 | mA | |
| | | | | | Resonator connection | | 1.1 | 1.7 | mA | |
| | | | f _{MX} = 8 MHz ^{Note 2} , V _{DD} = 2.0 V | Normal operation | Square wave input | | 1.1 | 1.7 | mA | |
| | | | | | Resonator connection | | 1.1 | 1.7 | mA | |
| Subsystem clock operation | f _{SUB} = 32.768 kHz ^{Note 4} T _A = -40°C | Normal operation | Square wave input | | 4.1 | 4.9 | μA | | | |
| | | | Resonator connection | | 4.2 | 5.0 | μA | | | |
| | | Normal operation | Square wave input | | 4.1 | 4.9 | μA | | | |
| | | | Resonator connection | | 4.2 | 5.0 | μA | | | |
| | | Normal operation | Square wave input | | 4.2 | 5.5 | μA | | | |
| | | | Resonator connection | | 4.3 | 5.6 | μA | | | |
| | f _{SUB} = 32.768 kHz ^{Note 4} T _A = +50°C | Normal operation | Square wave input | | 4.3 | 6.3 | μA | | | |
| | | | Resonator connection | | 4.4 | 6.4 | μA | | | |
| | f _{SUB} = 32.768 kHz ^{Note 4} T _A = +70°C | Normal operation | Square wave input | | 4.6 | 7.7 | μA | | | |
| | | | Resonator connection | | 4.7 | 7.8 | μA | | | |
| | f _{SUB} = 32.768 kHz ^{Note 4} T _A = +85°C | Normal operation | Square wave input | | 4.6 | 7.7 | μA | | | |
| | | | Resonator connection | | 4.7 | 7.8 | μA | | | |

(Notes and Remarks are listed on the next page.)

- Notes**
1. Total current flowing into V_{DD}, EV_{DD0}, and EV_{DD1}, including the input leakage current flowing when the level of the input pin is fixed to V_{DD}, EV_{DD0}, and EV_{DD1}, or V_{SS}, EV_{SS0}, and EV_{SS1}. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
 2. When high-speed on-chip oscillator and subsystem clock are stopped.
 3. When high-speed system clock and subsystem clock are stopped.
 4. When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
 5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
 - HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to } 32\text{ MHz}$
 $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to } 16\text{ MHz}$
 - LS (low-speed main) mode: $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to } 8\text{ MHz}$
 - LV (low-voltage main) mode: $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V} @ 1\text{ MHz to } 4\text{ MHz}$

- Remarks**
1. f_{MX}: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 2. f_{IH}: High-speed on-chip oscillator clock frequency
 3. f_{SUB}: Subsystem clock frequency (XT1 clock oscillation frequency)
 4. Except subsystem clock operation, temperature condition of the TYP. value is T_A = 25°C

- Remarks 1.** p: CSI number (p = 00, 01, 10, 11, 20, 21, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 0 to 3),
 g: PIM and POM numbers (g = 0, 1, 4, 5, 8, 14)
- 2.** f_{MCK}: Serial array unit operation clock frequency
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

(4) During communication at same potential (CSI mode) (slave mode, SCKp... external clock input) (1/2)
 (T_A = -40 to +85°C, 1.6 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit | |
|--|--|-----------------------------------|---------------------------|---------------------------|-----------------------------|---------------------------|-----------------------------|---------------------------|-----------------------------|----|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | | |
| SCKp cycle time <small>Note 5</small> | t _{KCY2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | 20 MHz < f _{MCK} | 8/f _{MCK} | | — | | — | ns | |
| | | | f _{MCK} ≤ 20 MHz | 6/f _{MCK} | | 6/f _{MCK} | | 6/f _{MCK} | ns | |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | 16 MHz < f _{MCK} | 8/f _{MCK} | | — | | — | ns | |
| | | | f _{MCK} ≤ 16 MHz | 6/f _{MCK} | | 6/f _{MCK} | | 6/f _{MCK} | ns | |
| | | 2.4 V ≤ EV _{DD0} ≤ 5.5 V | | | 6/f _{MCK} and 500 | | 6/f _{MCK} and 500 | | 6/f _{MCK} and 500 | ns |
| | | 1.8 V ≤ EV _{DD0} ≤ 5.5 V | | | 6/f _{MCK} and 750 | | 6/f _{MCK} and 750 | | 6/f _{MCK} and 750 | ns |
| | | 1.7 V ≤ EV _{DD0} ≤ 5.5 V | | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | ns |
| | | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | | — | | 6/f _{MCK} and 1500 | | 6/f _{MCK} and 1500 | ns |
| SCKp high-/low-level width | t _{KH2} , t _{KL2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 7 | | t _{KCY2} /2 – 7 | | t _{KCY2} /2 – 7 | ns | |
| | | 2.7 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 8 | | t _{KCY2} /2 – 8 | | t _{KCY2} /2 – 8 | ns | |
| | | 1.8 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 18 | | t _{KCY2} /2 – 18 | | t _{KCY2} /2 – 18 | ns | |
| | | 1.7 V ≤ EV _{DD0} ≤ 5.5 V | | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | ns | |
| | | 1.6 V ≤ EV _{DD0} ≤ 5.5 V | | | — | t _{KCY2} /2 – 66 | | t _{KCY2} /2 – 66 | ns | |

(Notes, Caution, and Remarks are listed on the next page.)

(9) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (slave mode, SCKp... external clock input)**(T_A = -40 to +85°C, 1.8 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V) (2/2)**

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|--|--|---|------------------------------|-----------------------------|------------------------------|-----------------------------|------------------------------|-----------------------------|------|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp high-/low-level width | t _{KH2} , t _{KL2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V | t _{KCY2} /2 - 12 | | t _{KCY2} /2 - 50 | | t _{KCY2} /2 - 50 | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V | t _{KCY2} /2 - 18 | | t _{KCY2} /2 - 50 | | t _{KCY2} /2 - 50 | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} | t _{KCY2} /2 - 50 | | t _{KCY2} /2 - 50 | | t _{KCY2} /2 - 50 | | ns |
| Slp setup time (to SCKp↑) ^{Note 3} | t _{SIK2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V | 1/f _{MCK} + 20 | | 1/f _{MCK} + 30 | | 1/f _{MCK} + 30 | | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V | 1/f _{MCK} + 20 | | 1/f _{MCK} + 30 | | 1/f _{MCK} + 30 | | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} | 1/f _{MCK} + 30 | | 1/f _{MCK} + 30 | | 1/f _{MCK} + 30 | | ns |
| Slp hold time (from SCKp↑) ^{Note 4} | t _{SI2} | | 1/f _{MCK} + 31 | | 1/f _{MCK} + 31 | | 1/f _{MCK} + 31 | | ns |
| Delay time from SCKp↓ to SOp output ^{Note 5} | t _{KSO2} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 30 pF, R _b = 1.4 kΩ | | 2/f _{MCK} + 120 | | 2/f _{MCK} + 573 | | 2/f _{MCK} + 573 | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 30 pF, R _b = 2.7 kΩ | | 2/f _{MCK} + 214 | | 2/f _{MCK} + 573 | | 2/f _{MCK} + 573 | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} , C _b = 30 pF, R _b = 5.5 kΩ | | 2/f _{MCK} + 573 | | 2/f _{MCK} + 573 | | 2/f _{MCK} + 573 | ns |

Notes 1. Transfer rate in the SNOOZE mode : MAX. 1 Mbps2. Use it with EV_{DD0} ≥ V_b.3. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The Slp setup time becomes “to SCKp↓” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.4. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The Slp hold time becomes “from SCKp↓” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.5. When DAP_{mn} = 0 and CKP_{mn} = 0, or DAP_{mn} = 1 and CKP_{mn} = 1. The delay time to SOp output becomes “from SCKp↑” when DAP_{mn} = 0 and CKP_{mn} = 1, or DAP_{mn} = 1 and CKP_{mn} = 0.

Caution Select the TTL input buffer for the Slp pin and the N-ch open drain output (V_{DD} tolerance (for the 20- to 52-pin products)/EV_{DD} tolerance (for the 64- to 128-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V_{IH} and V_{IL}, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

(10) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified I²C mode) (2/2)**(T_A = -40 to +85°C, 1.8 V ≤ EV_{DD0} = EV_{DD1} ≤ V_{DD} ≤ 5.5 V, V_{SS} = EV_{SS0} = EV_{SS1} = 0 V)**

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|-------------------------------|---------------------|--|---|------|---|------|---|------|------|
| | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| Data setup time (reception) | t _{SU:DAT} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 50 pF, R _b = 2.7 kΩ | 1/f _{MCK} + 135 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | kHz |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 50 pF, R _b = 2.7 kΩ | 1/f _{MCK} + 135 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | kHz |
| | | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 100 pF, R _b = 2.8 kΩ | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | kHz |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 100 pF, R _b = 2.7 kΩ | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | kHz |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} , C _b = 100 pF, R _b = 5.5 kΩ | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | 1/f _{MCK} + 190 ^{Note 3} | | kHz |
| Data hold time (transmission) | t _{HD:DAT} | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 50 pF, R _b = 2.7 kΩ | 0 | 305 | 0 | 305 | 0 | 305 | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 50 pF, R _b = 2.7 kΩ | 0 | 305 | 0 | 305 | 0 | 305 | ns |
| | | 4.0 V ≤ EV _{DD0} ≤ 5.5 V, 2.7 V ≤ V _b ≤ 4.0 V, C _b = 100 pF, R _b = 2.8 kΩ | 0 | 355 | 0 | 355 | 0 | 355 | ns |
| | | 2.7 V ≤ EV _{DD0} < 4.0 V, 2.3 V ≤ V _b ≤ 2.7 V, C _b = 100 pF, R _b = 2.7 kΩ | 0 | 355 | 0 | 355 | 0 | 355 | ns |
| | | 1.8 V ≤ EV _{DD0} < 3.3 V, 1.6 V ≤ V _b ≤ 2.0 V ^{Note 2} , C _b = 100 pF, R _b = 5.5 kΩ | 0 | 405 | 0 | 405 | 0 | 405 | ns |

- Notes**
1. The value must also be equal to or less than f_{MCK}/4.
 2. Use it with EV_{DD0} ≥ V_b.
 3. Set the f_{MCK} value to keep the hold time of SCLr = "L" and SCLr = "H".

Caution Select the TTL input buffer and the N-ch open drain output (V_{DD} tolerance (for the 20- to 52-pin products)/EV_{DD} tolerance (for the 64- to 128-pin products)) mode for the SDAr pin and the N-ch open drain output (V_{DD} tolerance (for the 20- to 52-pin products)/EV_{DD} tolerance (for the 64- to 128-pin products)) mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V_{IH} and V_{IL}, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

2.6.4 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode(T_A = -40 to +85°C, V_{PDR} ≤ V_{DD} ≤ 5.5 V, V_{SS} = 0 V)

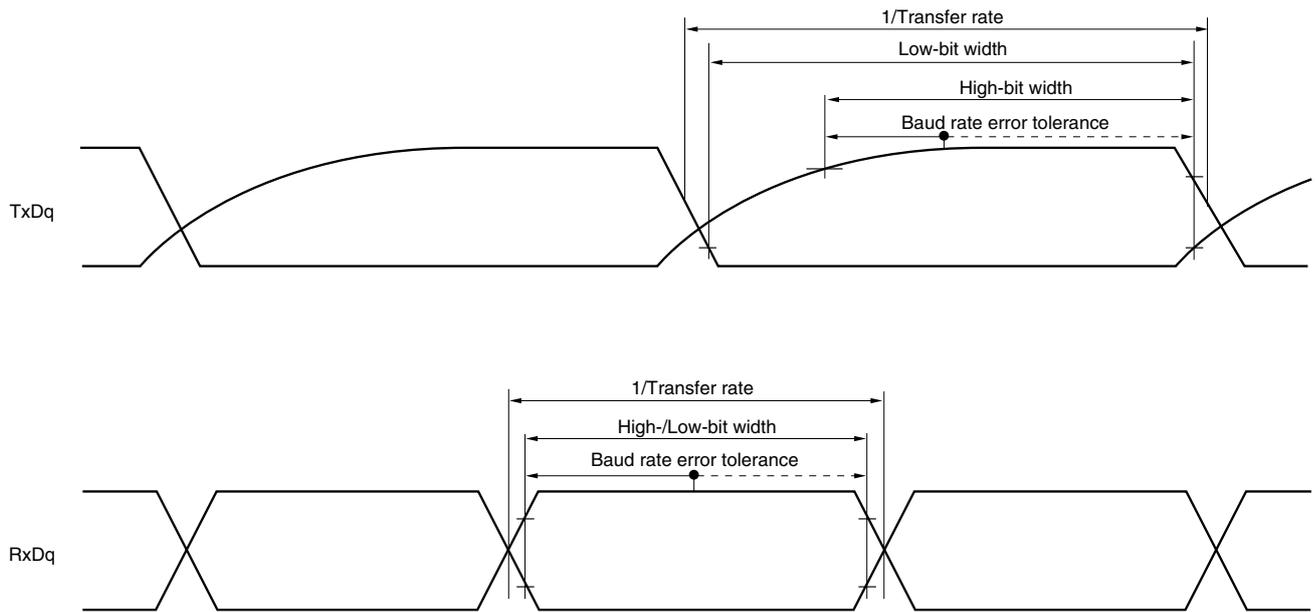
| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------|------------------------|--------------------|------------------------|------|------|------|------|
| Detection voltage | Supply voltage level | V _{LVD0} | Power supply rise time | 3.98 | 4.06 | 4.14 | V |
| | | | Power supply fall time | 3.90 | 3.98 | 4.06 | V |
| | | V _{LVD1} | Power supply rise time | 3.68 | 3.75 | 3.82 | V |
| | | | Power supply fall time | 3.60 | 3.67 | 3.74 | V |
| | | V _{LVD2} | Power supply rise time | 3.07 | 3.13 | 3.19 | V |
| | | | Power supply fall time | 3.00 | 3.06 | 3.12 | V |
| | | V _{LVD3} | Power supply rise time | 2.96 | 3.02 | 3.08 | V |
| | | | Power supply fall time | 2.90 | 2.96 | 3.02 | V |
| | | V _{LVD4} | Power supply rise time | 2.86 | 2.92 | 2.97 | V |
| | | | Power supply fall time | 2.80 | 2.86 | 2.91 | V |
| | | V _{LVD5} | Power supply rise time | 2.76 | 2.81 | 2.87 | V |
| | | | Power supply fall time | 2.70 | 2.75 | 2.81 | V |
| | | V _{LVD6} | Power supply rise time | 2.66 | 2.71 | 2.76 | V |
| | | | Power supply fall time | 2.60 | 2.65 | 2.70 | V |
| | | V _{LVD7} | Power supply rise time | 2.56 | 2.61 | 2.66 | V |
| | | | Power supply fall time | 2.50 | 2.55 | 2.60 | V |
| | | V _{LVD8} | Power supply rise time | 2.45 | 2.50 | 2.55 | V |
| | | | Power supply fall time | 2.40 | 2.45 | 2.50 | V |
| | | V _{LVD9} | Power supply rise time | 2.05 | 2.09 | 2.13 | V |
| | | | Power supply fall time | 2.00 | 2.04 | 2.08 | V |
| | | V _{LVD10} | Power supply rise time | 1.94 | 1.98 | 2.02 | V |
| | | | Power supply fall time | 1.90 | 1.94 | 1.98 | V |
| | | V _{LVD11} | Power supply rise time | 1.84 | 1.88 | 1.91 | V |
| | | | Power supply fall time | 1.80 | 1.84 | 1.87 | V |
| | | V _{LVD12} | Power supply rise time | 1.74 | 1.77 | 1.81 | V |
| | | | Power supply fall time | 1.70 | 1.73 | 1.77 | V |
| V _{LVD13} | Power supply rise time | 1.64 | 1.67 | 1.70 | V | | |
| | Power supply fall time | 1.60 | 1.63 | 1.66 | V | | |
| Minimum pulse width | t _{LW} | | 300 | | | μs | |
| Detection delay time | | | | | 300 | μs | |

- Notes**
1. Total current flowing into V_{DD} and EV_{DD0} , including the input leakage current flowing when the level of the input pin is fixed to V_{DD} , EV_{DD0} or V_{SS} , EV_{SS0} . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
 2. When high-speed on-chip oscillator and subsystem clock are stopped.
 3. When high-speed system clock and subsystem clock are stopped.
 4. When high-speed on-chip oscillator and high-speed system clock are stopped. When $AMPHS1 = 1$ (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
 5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode: $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }32\text{ MHz}$

$2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }16\text{ MHz}$

- Remarks**
1. f_{MX} : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
 2. f_{IH} : High-speed on-chip oscillator clock frequency
 3. f_{SUB} : Subsystem clock frequency (XT1 clock oscillation frequency)
 4. Except subsystem clock operation, temperature condition of the TYP. value is $T_A = 25^\circ\text{C}$

UART mode bit width (during communication at different potential) (reference)

- Remarks**
1. $R_b[\Omega]$: Communication line (TxDq) pull-up resistance,
 $C_b[\text{F}]$: Communication line (TxDq) load capacitance, $V_b[\text{V}]$: Communication line voltage
 2. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
 3. f_{MCK} : Serial array unit operation clock frequency
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
 m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))
 4. UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified I²C mode) (2/2)**($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$, $\text{V}_{\text{SS}} = \text{EV}_{\text{SS}0} = \text{EV}_{\text{SS}1} = 0\text{ V}$)**

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | Unit |
|-------------------------------|---------------------|--|---|------|------|
| | | | MIN. | MAX. | |
| Data setup time (reception) | $t_{\text{SU:DAT}}$ | $4.0\text{ V} \leq \text{EV}_{\text{DD}0} \leq 5.5\text{ V}$, $2.7\text{ V} \leq \text{V}_b \leq 4.0\text{ V}$, $C_b = 50\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | $1/f_{\text{MCK}} + 340$ <small>Note 2</small> | | ns |
| | | $2.7\text{ V} \leq \text{EV}_{\text{DD}0} < 4.0\text{ V}$, $2.3\text{ V} \leq \text{V}_b \leq 2.7\text{ V}$, $C_b = 50\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | $1/f_{\text{MCK}} + 340$ <small>Note 2</small> | | ns |
| | | $4.0\text{ V} \leq \text{EV}_{\text{DD}0} \leq 5.5\text{ V}$, $2.7\text{ V} \leq \text{V}_b \leq 4.0\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 2.8\text{ k}\Omega$ | $1/f_{\text{MCK}} + 760$ <small>Note 2</small> | | ns |
| | | $2.7\text{ V} \leq \text{EV}_{\text{DD}0} < 4.0\text{ V}$, $2.3\text{ V} \leq \text{V}_b \leq 2.7\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | $1/f_{\text{MCK}} + 760$ <small>Note 2</small> | | ns |
| | | $2.4\text{ V} \leq \text{EV}_{\text{DD}0} < 3.3\text{ V}$, $1.6\text{ V} \leq \text{V}_b \leq 2.0\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 5.5\text{ k}\Omega$ | $1/f_{\text{MCK}} + 570$ <small>Note 2</small> | | ns |
| Data hold time (transmission) | $t_{\text{HD:DAT}}$ | $4.0\text{ V} \leq \text{EV}_{\text{DD}0} \leq 5.5\text{ V}$, $2.7\text{ V} \leq \text{V}_b \leq 4.0\text{ V}$, $C_b = 50\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | 0 | 770 | ns |
| | | $2.7\text{ V} \leq \text{EV}_{\text{DD}0} < 4.0\text{ V}$, $2.3\text{ V} \leq \text{V}_b \leq 2.7\text{ V}$, $C_b = 50\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | 0 | 770 | ns |
| | | $4.0\text{ V} \leq \text{EV}_{\text{DD}0} \leq 5.5\text{ V}$, $2.7\text{ V} \leq \text{V}_b \leq 4.0\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 2.8\text{ k}\Omega$ | 0 | 1420 | ns |
| | | $2.7\text{ V} \leq \text{EV}_{\text{DD}0} < 4.0\text{ V}$, $2.3\text{ V} \leq \text{V}_b \leq 2.7\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 2.7\text{ k}\Omega$ | 0 | 1420 | ns |
| | | $2.4\text{ V} \leq \text{EV}_{\text{DD}0} < 3.3\text{ V}$, $1.6\text{ V} \leq \text{V}_b \leq 2.0\text{ V}$, $C_b = 100\text{ pF}$, $R_b = 5.5\text{ k}\Omega$ | 0 | 1215 | ns |

Notes 1. The value must also be equal to or less than $f_{\text{MCK}}/4$.**2.** Set the f_{MCK} value to keep the hold time of $\text{SCLr} = \text{"L"}$ and $\text{SCLr} = \text{"H"}$.

Caution Select the TTL input buffer and the N-ch open drain output (V_{DD} tolerance (for the 20- to 52-pin products)/ EV_{DD} tolerance (for the 64- to 100-pin products)) mode for the SDAr pin and the N-ch open drain output (V_{DD} tolerance (for the 20- to 52-pin products)/ EV_{DD} tolerance (for the 64- to 100-pin products)) mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V_{IH} and V_{IL} , see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

(2) When reference voltage (+) = $AV_{REFP}/ANI0$ ($ADREFP1 = 0$, $ADREFP0 = 1$), reference voltage (-) = $AV_{REFM}/ANI1$ ($ADREFM = 1$), target pin : ANI16 to ANI26

($T_A = -40$ to $+105^\circ\text{C}$, $2.4\text{ V} \leq EV_{DD0} = EV_{DD1} \leq V_{DD} \leq 5.5\text{ V}$, $2.4\text{ V} \leq AV_{REFP} \leq V_{DD} \leq 5.5\text{ V}$, $V_{SS} = EV_{SS0} = EV_{SS1} = 0\text{ V}$, Reference voltage (+) = AV_{REFP} , Reference voltage (-) = $AV_{REFM} = 0\text{ V}$)

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|--|------------|---|---|--------|----------------------------------|---------------|
| Resolution | RES | | 8 | | 10 | bit |
| Overall error ^{Note 1} | AINL | 10-bit resolution $EV_{DD0} \leq AV_{REFP} = V_{DD}$ ^{Notes 3, 4} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | 1.2 | ± 5.0 | LSB |
| Conversion time | t_{CONV} | 10-bit resolution Target pin : ANI16 to ANI26 | $3.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 2.125 | 39 | μs |
| | | | $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 3.1875 | 39 | μs |
| | | | $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ | 17 | 39 | μs |
| Zero-scale error ^{Notes 1, 2} | EZS | 10-bit resolution $EV_{DD0} \leq AV_{REFP} = V_{DD}$ ^{Notes 3, 4} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 0.35 | %FSR |
| Full-scale error ^{Notes 1, 2} | EFS | 10-bit resolution $EV_{DD0} \leq AV_{REFP} = V_{DD}$ ^{Notes 3, 4} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 0.35 | %FSR |
| Integral linearity error ^{Note 1} | ILE | 10-bit resolution $EV_{DD0} \leq AV_{REFP} = V_{DD}$ ^{Notes 3, 4} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 3.5 | LSB |
| Differential linearity error ^{Note 1} | DLE | 10-bit resolution $EV_{DD0} \leq AV_{REFP} = V_{DD}$ ^{Notes 3, 4} | $2.4\text{ V} \leq AV_{REFP} \leq 5.5\text{ V}$ | | ± 2.0 | LSB |
| Analog input voltage | V_{AIN} | ANI16 to ANI26 | 0 | | AV_{REFP} and EV_{DD0} | V |

Notes 1. Excludes quantization error ($\pm 1/2$ LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. When $AV_{REFP} < V_{DD}$, the MAX. values are as follows.

Overall error: Add ± 1.0 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.

Zero-scale error/Full-scale error: Add $\pm 0.05\%$ FSR to the MAX. value when $AV_{REFP} = V_{DD}$.

Integral linearity error/ Differential linearity error: Add ± 0.5 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.

4. When $AV_{REFP} < EV_{DD0} \leq V_{DD}$, the MAX. values are as follows.

Overall error: Add ± 4.0 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.

Zero-scale error/Full-scale error: Add $\pm 0.20\%$ FSR to the MAX. value when $AV_{REFP} = V_{DD}$.

Integral linearity error/ Differential linearity error: Add ± 2.0 LSB to the MAX. value when $AV_{REFP} = V_{DD}$.

3.6.4 LVD circuit characteristics

LVD Detection Voltage of Reset Mode and Interrupt Mode**($T_A = -40$ to $+105^\circ\text{C}$, $V_{PDR} \leq V_{DD} \leq 5.5$ V, $V_{SS} = 0$ V)**

| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|----------------------|----------------------|-------------------|------------------------|------|------|------|------|
| Detection voltage | Supply voltage level | V _{LVD0} | Power supply rise time | 3.90 | 4.06 | 4.22 | V |
| | | | Power supply fall time | 3.83 | 3.98 | 4.13 | V |
| | | V _{LVD1} | Power supply rise time | 3.60 | 3.75 | 3.90 | V |
| | | | Power supply fall time | 3.53 | 3.67 | 3.81 | V |
| | | V _{LVD2} | Power supply rise time | 3.01 | 3.13 | 3.25 | V |
| | | | Power supply fall time | 2.94 | 3.06 | 3.18 | V |
| | | V _{LVD3} | Power supply rise time | 2.90 | 3.02 | 3.14 | V |
| | | | Power supply fall time | 2.85 | 2.96 | 3.07 | V |
| | | V _{LVD4} | Power supply rise time | 2.81 | 2.92 | 3.03 | V |
| | | | Power supply fall time | 2.75 | 2.86 | 2.97 | V |
| | | V _{LVD5} | Power supply rise time | 2.70 | 2.81 | 2.92 | V |
| | | | Power supply fall time | 2.64 | 2.75 | 2.86 | V |
| | | V _{LVD6} | Power supply rise time | 2.61 | 2.71 | 2.81 | V |
| | | | Power supply fall time | 2.55 | 2.65 | 2.75 | V |
| | | V _{LVD7} | Power supply rise time | 2.51 | 2.61 | 2.71 | V |
| | | | Power supply fall time | 2.45 | 2.55 | 2.65 | V |
| Minimum pulse width | | t _{LW} | | 300 | | | μs |
| Detection delay time | | | | | | 300 | μs |

LVD Detection Voltage of Interrupt & Reset Mode**($T_A = -40$ to $+105^\circ\text{C}$, $V_{PDR} \leq V_{DD} \leq 5.5$ V, $V_{SS} = 0$ V)**

| Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit | |
|--------------------------|--------------------|--|------------------------------|------|------|------|---|
| Interrupt and reset mode | V _{LVDD0} | V _{POC2} , V _{POC1} , V _{POC0} = 0, 1, 1, falling reset voltage | 2.64 | 2.75 | 2.86 | V | |
| | V _{LVDD1} | LVIS1, LVIS0 = 1, 0 | Rising release reset voltage | 2.81 | 2.92 | 3.03 | V |
| | | | Falling interrupt voltage | 2.75 | 2.86 | 2.97 | V |
| | V _{LVDD2} | LVIS1, LVIS0 = 0, 1 | Rising release reset voltage | 2.90 | 3.02 | 3.14 | V |
| | | | Falling interrupt voltage | 2.85 | 2.96 | 3.07 | V |
| | V _{LVDD3} | LVIS1, LVIS0 = 0, 0 | Rising release reset voltage | 3.90 | 4.06 | 4.22 | V |
| | | | Falling interrupt voltage | 3.83 | 3.98 | 4.13 | V |

| Rev. | Date | Description | |
|----------|--|-------------|--|
| | | Page | Summary |
| 3.00 | Aug 02, 2013 | 118 | Modification of table in 2.6.2 Temperature sensor/internal reference voltage characteristics |
| | | 118 | Modification of table and note in 2.6.3 POR circuit characteristics |
| | | 119 | Modification of table in 2.6.4 LVD circuit characteristics |
| | | 120 | Modification of table of LVD Detection Voltage of Interrupt & Reset Mode |
| | | 120 | Renamed to 2.6.5 Power supply voltage rising slope characteristics |
| | | 122 | Modification of table, figure, and remark in 2.10 Timing Specs for Switching Flash Memory Programming Modes |
| | | 123 | Modification of caution 1 and description |
| | | 124 | Modification of table and remark 3 in Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$) |
| | | 126 | Modification of table, note, caution, and remark in 3.2.1 X1, XT1 oscillator characteristics |
| | | 126 | Modification of table in 3.2.2 On-chip oscillator characteristics |
| | | 127 | Modification of note 3 in 3.3.1 Pin characteristics (1/5) |
| | | 128 | Modification of note 3 in 3.3.1 Pin characteristics (2/5) |
| | | 133 | Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (1/2) |
| | | 135 | Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products (2/2) |
| | | 137 | Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (1/2) |
| | | 139 | Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (2/2) |
| | | 140 | Modification of (3) Peripheral Functions (Common to all products) |
| | | 142 | Modification of table in 3.4 AC Characteristics |
| | | 143 | Addition of Minimum Instruction Execution Time during Main System Clock Operation |
| | | 143 | Modification of figure of AC Timing Test Points |
| | | 143 | Modification of figure of External System Clock Timing |
| | | 145 | Modification of figure of AC Timing Test Points |
| | | 145 | Modification of description, note 1, and caution in (1) During communication at same potential (UART mode) |
| | | 146 | Modification of description in (2) During communication at same potential (CSI mode) |
| | | 147 | Modification of description in (3) During communication at same potential (CSI mode) |
| | | 149 | Modification of table, note 1, and caution in (4) During communication at same potential (simplified I ² C mode) |
| | | 151 | Modification of table, note 1, and caution in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2) |
| | | 152 to 154 | Modification of table, notes 2 to 6, caution, and remarks 1 to 4 in (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (2/2) |
| | | 155 | Modification of table in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (1/3) |
| | | 156 | Modification of table and caution in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (2/3) |
| 157, 158 | Modification of table, caution, and remarks 3 and 4 in (6) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (3/3) | | |
| 160, 161 | Modification of table and caution in (7) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) | | |